05 May 20			T	09/72
L Number	Hits	Search Text	DB	Time stam
6	2	6001229.pn.	USPAT;	2004/05/0
			US-PGPUB;	09:47
			EPO; JPO; DERWENT;	ļ
			IBM_TDB	
12	210	204/450-470,600-621.ccls. and	USPAT;	2004/05/0
12	210	(polytetrafluoroethylene or PTFE)	US-PGPUB;	09:48
		(polyterratidor de ritylene di 1 11 C)	EPO; JPO;	05.40
			DERWENT;	
			IBM_TDB	
13	176	204/600-621.ccls. and (polytetrafluoroethylene or	USPAT;	2004/05/0
		PTFE)	US-PGPUB;	09:51
			EPO; JPO;	
			DERWENT;]
			IBM_TDB	
14	4	6321791.pn. 6167910.pn.	USPAT;	2004/05/0
		,	U5-PGPUB;	09:57
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
15	418	204/600,601,606.ccls. and array and (plate or chip or	USPAT;	2004/05/0
		microchip or microfluidic)	U5-PGPUB;	10:15
			EPO; JPO;	
,			DERWENT;	
			IBW_TDB	
16	23	204/\$.ccls. and aclara.asn.	USPAT;	2004/05/0
		•	US-PGPUB;	10:15
			EPO; JPO;	1
			DERWENT;	1
	00/0		IBM_TDB	0004/04/
-	2068	sample.ti. and plate.ti.	USPAT;	2004/04/3
			US-PGPUB;	09:26
			EPO; JPO;	
			DERWENT; IBM_TDB	
_	141	sample.ti. and plate.ti. and well.ti.	USPAT;	2003/09/2
	A-714	amportant protects and wonth.	US-PGPUB;	13:44
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	25	US-4797259-\$.DID. OR US-4927604-\$.DID. OR	USPAT	2004/04/2
		US-5580747-\$.DID. OR US-5605662-\$.DID. OR		10:20
		US-5632957-\$.DID. OR US-5849486-\$.DID. OR		
		US-5129208-\$.DID. OR US-6017696-\$.DID. OR		
		US-6051380-\$.DID. OR US-5376252-\$.DID. OR		
		US-5580747-\$.DID. OR US-5858188-\$.DID. OR		
		US-5904824-\$.DID. OR US-5932315-\$.DID. OR		
		U5-5942443-\$.DID. OR US-5948227-\$.DID. OR		
		US-5957579-\$.DID. OR US-5958202-\$.DID. OR		
		US-5965001-\$.DID. OR US-5976336-\$.DID. OR		
		US-6046056-\$.DID. OR US-6068752-\$.DID. OR		
		US-6074827-\$.DID. OR US-6093296-\$.DID. OR	I	1

	1	· (0047047 & 1:1	HCDAT	2004/04/20
-	2	jp-62247247-\$.did.	USPAT;	2004/04/28
		\	US-PGPUB;	10:48
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	1987-344377.NRAN.	DERWENT	2004/04/28
				10:21
-	1	1997wo-us13525.ap,prai.	USPAT;	2004/04/28
			US-PGPUB;	10:49
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	1998-193779.NRAN.	DERWENT	2004/04/28
				10:48
-	2	6129828.pn.	USPAT;	2004/04/28
			US-PGPUB;	10:49
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			DERWENT;	
			IBM_TDB	
_	1	2000wo-us05320.ap,prai.	USPAT;	2004/04/28
			US-PGPUB;	10:50
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			IBM_TDB	
_	2	6585939.pn.	USPAT;	2004/04/28
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			DERWENT;	
			IBM_TDB	
_	1	1998wo-us21869.ap,prai.	USPAT;	2004/04/28
-	•	177000 0321007.047,51 01.	US-PGPUB;	10:51
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	4	6129828.pn. 6585939.pn.	USPAT;	2004/04/28
		012/020.pm. 0000/07.pm.	US-PGPUB;	10:54
			EPO; JPO;	-0.0
			DERWENT;	
			IBM_TDB	
	2202	204/600,601,605,606,614,627,630-640.ccls.	USPAT;	2004/04/28
-	2202		US-PGPUB;	10:59
			EPO; JPO;	10.59
			DERWENT;	
			· ·	
	2	4054950 mm	IBM_TDB USPAT;	2004/04/28
-	4	6056859.pn.	USPAT; US-PGPUB;	11:00
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			EPO; JPO; DERWENT;	
		204/627 -	IBM_TDB	2004/04/28
-	218	204/627.ccls.	USPAT;	2004/04/28
			US-PGPUB;	13:58
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

	878	204/627-640.ccls.	USPAT;	2004/04/30
	0,0	2047027 0 10.0013.	US-PGPUB;	10:11
			EPO; JPO;	10.11
			DERWENT;	
			IBM_TDB	
	23	204/627-640.ccls. and (microfluid\$4 or microconduit	USPAT;	2004/04/28
		or chip or tas! wafer)	US-PGPUB;	15:07
		or employ rus: warer)	EPO; JPO;	15.07
			DERWENT;	
			· ·	
	7	6103537.URPN.	IBM_TDB USPAT	2004/04/29
-	'	0103537.0RFN.	USPAT	2004/04/28 14:22
	30	/#2025074# #2094522# #2004245# #4008974#	LICDAT	
-	30	("3935074" "3984533" "3996345" "4098876"	USPAT	2004/04/28
		"4141687" "4275149" "4318980" "4529561"		14:32
		"4619904" "4628037" "4634681" "4652533"		
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	[i	"5630924" "5685965" "5810985" "5833826"		
	_	"5853668" "5898005").PN.		
-	2	204/600,601,605,606,614,627,630-640.ccls. and	USPAT;	2004/04/28
		(capture adj matrix)	US-PGPUB;	15:07
	-		EPO; JPO;	
			DERWENT;	
			IBW_TDB	
j -	325	204/600,601,605,606,614,627,630-640.ccls. and	USPAT;	2004/04/28
		(binding)	US-PGPUB;	15:07
		v.	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	168	(204/600,601,605,606,614,627,630-640.ccls. and	USPAT;	2004/04/28
		(binding)) and (microfluid\$4 or microconduit or chip	US-PGPUB;	15:08
		or tas! wafer)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	1998-193779.NRAN.	DERWENT	2004/04/29
				15:01
-	280	204/627-640.ccls. and plate	USPAT;	2004/04/29
		·	US-PGPUB;	15:25
			EPO; JPO;	
]		DERWENT;	1
			IBM_TDB	
_	95	(204/627-640.ccls. and plate) and (quantit\$7 or	USPAT;	2004/04/29
		quantif\$7)	US-PGPUB;	15:25
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1	2001WO-U546035.ap,prai.	USPAT;	2004/04/30
		L d	US-PGPUB;	09:53
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1	2002-566566.NRAN.	DERWENT	2004/04/30
	*		J C. 177 C. 1 1	09:54
	1			1 22.0

-	114	204/627-640.ccls. and gradient	USPAT;	2004/04/30
		_	US-PGPUB;	10:11
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	jp-11311616-\$.did.	USPAT;	2004/05/04
			US-PGPUB;	13:51
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	2000-048669.NRAN.	DERWENT	2004/05/04
1				14:00